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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Discontinued at Digi-Key
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	120MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I ² C, LINbus, MMC/SD, SCI, SPI, SSI, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	127
Program Memory Size	3MB (3M x 8)
Program Memory Type	FLASH
EEPROM Size	64K x 8
RAM Size	552K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 29x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	176-LQFP
Supplier Device Package	176-LFQFP (24x24)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f564mjgdfc-v1

Table 1.1 Outline of Specifications (7/9)

Classification	Module/Function	Description
Communication function	I ² C bus interface (RIICa)	<ul style="list-style-type: none"> • 2 channels (only channel 0 can be used in fast-mode plus) • Communication formats • I²C bus format/SMBus format • Supports the multi-master • Max. transfer rate: 1 Mbps (channel 0) • Event linking by the ELC
	CAN module (CAN)	<ul style="list-style-type: none"> • 3 channels • Compliance with the ISO11898-1 specification (standard frame and extended frame) • 32 mailboxes per channel
	Serial peripheral interface (RSPPIa)	<ul style="list-style-type: none"> • 1 channel • RSPPI transfer facility Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPCK (RSPPI clock) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) Capable of handling serial transfer as a master or slave • Data formats Switching between MSB first and LSB first The number of bits in each transfer can be changed to any number of bits from 8 to 16, or to 20, 24, or 32 bits. 128-bit buffers for transmission and reception Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) • Buffered structure Double buffers for both transmission and reception • RSPCK can be stopped with the receive buffer full for master reception. • Event linking by the ELC
	Quad serial peripheral interface (QSPI)	<ul style="list-style-type: none"> • 1 channel • Connectable with serial flash memory equipped with multiple input and output lines (i.e. for single, dual, or quad operation) • Programmable bit length and selectable active sense and phase of the clock signal • Sequential execution of transfer • LSB or MSB first is selectable.
	Serial sound interface (SSI)	<ul style="list-style-type: none"> • 2 channels • Full-duplex transfer is possible (only on channel 0). • Support for multiple audio formats • Support for master or slave operation • Bit clock frequency is selectable from four different types (16 fs, 32 fs, 48 fs, and 64 fs). • Support for 8-/16-/18-/20-/22-/24 bit data formats • Internal 8-stage FIFO for transmission and reception • Stopping SSIWS when data transfer is stopped is selectable.
	Sampling rate converter (SRC)	<ul style="list-style-type: none"> • 1 channel • Data formats: 32-bit stereo (16 bits for the left, 16 bits for the right) and 16-bit monaural. • Input sampling rates: 8, 11.025, 12, 16, 22.05, 24, 32, 44.1, 48 kHz • Output sampling rates: 32, 44.1, 48, 8*2 or 16 kHz*2
	SD host interface (SDHI)*4	<ul style="list-style-type: none"> • 1 channel • Transfer speed: Supports high-speed mode (15 MB/s) and default speed mode (10 MB/s) • One interface for SD memory and I/O cards (supporting 1- and 4-bit SD buses) • SD specifications <ul style="list-style-type: none"> Part 1: Physical Layer Specification Ver. 3.01 compliant (DDR not supported) Part E1: SDIO Specification Ver. 3.00 • Error checking: CRC7 for commands and CRC16 for data • Interrupt requests: Card access interrupt, SDIO access interrupt, card detection interrupt • DMA transfer requests: SD_BUFI write and SD_BUFI read • Support for card detection and write protection
	MMC host interface (MMCIF)	<ul style="list-style-type: none"> • 1 channel • Transfer speed: Supports high-speed mode (30 MB/s) and Backward-compatible mode (25 MB/s) • Compliant with JEDEC STANDARD JESD84-A441 (DDR is not supported) • Interface for Multimedia Cards (MMCs) • Device buses: Support for 1-, 4-, and 8-bit MMC buses • Interrupt requests: Card detection interrupt, error/timeout interrupt, normal operation interrupt • DMA transfer requests: CE_DATA write and CE_DATA read • Support for card detection, boot operation, high priority interrupt (HPI)

Table 1.6 List of Pin and Pin Functions (176-Pin LFQFP) (5/7)

Pin Number 176-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIG, SCH, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
111	TRDATA3	PG7	D31		ET1_TX_ER			
112		PA2	A2	MTIOC7A/GTIOC1A-C/PO18	RXD5/SMISO5/SSCL5/SSLA3-B			
113	TRDATA2	PG6	D30		ET1_ETXD3			
114		PA1	A1/DQM3	MTIOC0B/MTCLKC/MTIOC7B/GTIOC2A-C/TIOCB0/PO17	SCK5/SSLA2-B/ET0_WOL		IRQ11	
115	VCC							
116	TRCLK	PG5	D29		ET1_ETXD2			
117	VSS							
118		PA0	A0/BC0#/DQM2	MTIOC4A/MTIOC6D/GTIOC0B-C/TIOCA0/CACREF/PO16	SSLA1-B/ET0_RX_EN/RMII0_TXD_EN			
119	TRSYNC	PG4	D28		ET1_ETXD1/RMII1_TXD1			
120		P67	CS7#/DQM1	MTIOC7C/GTIOC1B-C	CRX2		IRQ15	
121	TRDATA1	PG3	D27		ET1_ETXD0/RMII1_TXD0			
122		P66	CS6#/DQM0	MTIOC7D/GTIOC2B-C	CTX2			
123	TRDATA0	PG2	D26		ET1_RX_CLK			
124		P65	CS5#/CKE					
125		PE7	D15[A15/D15]	MTIOC6A/GTIOC3A-E/TOC1		MMC_RES#-B/SDHI_WP-B	IRQ7	AN105
126		PE6	D14[A14/D14]	MTIOC6C/GTIOC3B-E/TIC1		MMC_CD-B/SDHI_CD-B	IRQ6	AN104
127	VCC							
128		P70	SDCLK					
129	VSS							
130		PE5	D13[A13/D13]	MTIOC4C/MTIOC2B/GTIOC0A-A	ET0_RX_CLK/REF50CK0		IRQ5	AN103
131		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/GTIOC1A-A/PO28	ET0_ERXD2			AN102
132		PE3	D11[A11/D11]	MTIOC4B/GTIOC2A-A/PO26/POE8#/TOC3	CTS12#/RTS12#/SS12#/ET0_ERXD3	MMC_D7-B		AN101
133		PE2	D10[A10/D10]	MTIOC4A/GTIOC0B-A/PO23/TIC3	RXD12/SMISO12/SSCL12/RDXD12	MMC_D6-B	IRQ7-DS	AN100
134		PE1	D9[A9/D9]	MTIOC4C/MTIOC3B/GTIOC1B-A/PO18	TXD12/SMOSI12/SSDA12/TDXD12/SIOX12	MMC_D5-B		ANEX1
135		PE0	D8[A8/D8]	MTIOC3D/GTIOC2B-A	SCK12	MMC_D4-B		ANEX0
136		P64	CS4#/WE#					
137		P63	CS3#/CAS#					
138		P62	CS2#/RAS#					
139		P61	CS1#/SDCS#					
140	VSS							
141		P60	CS0#		ET1_RX_EN/RMII1_TXD_EN			
142	VCC							

Table 1.8 List of Pin and Pin Functions (144-Pin LFQFP) (3/5)

Pin Number 144-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIG, SCH, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
63	TRSYNC	P82	EDREQ1	MTIOC4A/GTIOC2A-D/PO28	TXD10/ET0_ETXD1/RMII0_TXD1	MMC_D4-A		
64	TRDATA1	P81	EDACK0	MTIOC3D/GTIOC0B-D/PO27	RXD10/ET0_ETXD0/RMII0_RXD0	MMC_D3-A/SDHI_CD-A/QIO3-A		
65	TRDATA0	P80	EDREQ0	MTIOC3B/PO26	SCK10/RTS10#/ET0_TX_EN/RMII0_TXD_EN	MMC_D2-A/SDHI_WP-A/QIO2-A		
66		PC4	A20/CS3#	MTIOC3D/MTCLKC/GTETRG-D/TMC11/PO25/POE0#	SCK5/CTS8#/SSLA0-A/ET0_TX_CLK	MMC_D1-A/SDHI_D1-A/QIO1-A/QMI-A		
67		PC3	A19	MTIOC4D/GTIOC1B-D/TCLKB/PO24	TXD5/SMOSI5/SSDA5/ET0_RX_ER	MMC_D0-A/SDHI_D0-A/QIO0-A/QMO-A		
68		P77	CS7#	PO23	TXD11/ET0_RX_ER/RMII0_RX_ER	MMC_CLK-A/SDHI_CLK-A/QSPCLK-A		
69		P76	CS6#	PO22	RXD11/ET0_RX_CLK/REF50CK0	MMC_CMD-A/SDHI_CMD-A/QSSL-A		
70		PC2	A18	MTIOC4B/GTIOC2B-D/TCLKA/PO21	RXD5/SMISO5/SSCL5/SSLA3-A/ET0_RX_DV	MMC_CD-A/SDHI_D3-A		
71		P75	CS5#	PO20	SCK11/RTS11/ET0_ERXD0/RMII0_RXD0	MMC_RES#-A/SDHI_D2-A		
72		P74	A20/CS4#	PO19	CTS11#/ET0_ERXD1/RMII0_RXD1			
73		PC1	A17	MTIOC3A/TCLKD/PO18	SCK5/SSLA2-A/ET0_ERXD2		IRQ12	
74	VCC							
75		PC0	A16	MTIOC3C/TCLKC/PO17	CTS5#/RTS5#/SS5#/SSLA1-A/ET0_ERXD3		IRQ14	
76	VSS							
77		P73	CS3#	PO16	ET0_WOL			
78		PB7	A15	MTIOC3B/TIOCB5/PO31	TXD9/ET0_CRS/RMII0_CRS_DV			
79		PB6	A14	MTIOC3D/TIOCA5/PO30	RXD9/ET0_ETXD1/RMII0_TXD1			
80		PB5	A13	MTIOC2A/MTIOC1B/TIOCB4/TMRI1/PO29/POE4#	SCK9/RTS9#/ET0_ETXD0/RMII0_RXD0			
81		PB4	A12	TIOCA4/PO28	CTS9#/ET0_RX_EN/RMII0_RXD_EN			
82		PB3	A11	MTIOC0A/MTIOC4A/TIOCD3/TCLKD/TMO0/PO27/POE11#	SCK4/SCK6/ET0_RX_ER/RMII0_RX_ER			
83		PB2	A10	TIOCC3/TCLKC/PO26	CTS4#/RTS4#/CTS6#/RTS6#/SS4#/SS6#/ET0_RX_CLK/REF50CK0			
84		PB1	A9	MTIOC0C/MTIOC4C/TIOCB3/TMC10/PO25	TXD4/TXD6/SMOSI4/SMOSI6/SSDA4/SSDA6/ET0_RXD0/RMII0_RXD0		IRQ4-DS	
85		P72	A19/CS2#		ET0_MDC			
86		P71	A18/CS1#		ET0_MDIO			

Table 1.8 List of Pin and Pin Functions (144-Pin LFQFP) (4/5)

Pin Number 144-Pin LFQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, GPT, TPU, TMR, PPG, RTC, CMTW, POE, CAC)	Communication (ETHERC, SCIG, SCH, RSPI, RIIC, CAN, USB, SSI)	Memory Interface Camera Interface (QSPI, SDHI, MMCIF, PDC)	Interrupt	S12ADC, R12DA
87		PB0	A8	MTIC5W/TIOCA3/PO24	RXD4/RXD6/SMISO4/SMISO6/SSCL4/SSCL6/ET0_ERXD1/RMII0_RXD1		IRQ12	
88		PA7	A7	TIOCB2/PO23	MISOA-B/ET0_WOL			
89		PA6	A6	MTIC5V/MTCLKB/GTETRG-C/TIOCA2/TMC13/PO22/POE10#	CTS5#/RTS5#/SS5#/MOSIA-B/ET0_EXOUT			
90		PA5	A5	MTIOC6B/TIOCB1/GTIOC0A-C/PO21	RSPCKA-B/ET0_LINKSTA			
91	VCC							
92		PA4	A4	MTIC5U/MTCLKA/TIOCA1/TMRI0/PO20	TXD5/SMOSI5/SSDA5/SSLA0-B/ET0_MDC		IRQ5-DS	
93	VSS							
94		PA3	A3	MTIOC0D/MTCLKD/TIOCD0/TCLKB/PO19	RXD5/SMISO5/SSCL5/ET0_MDIO		IRQ6-DS	
95		PA2	A2	MTIOC7A/GTIOC1A-C/PO18	RXD5/SMISO5/SSCL5/SSLA3-B			
96		PA1	A1	MTIOC0B/MTCLKC/MTIOC7B/GTIOC2A-C/TIOCB0/PO17	SCK5/SSLA2-B/ET0_WOL		IRQ11	
97		PA0	A0/BC0#	MTIOC4A/MTIOC6D/GTIOC0B-C/TIOCA0/CACREF/PO16	SSLA1-B/ET0_TX_EN/RMII0_TXD_EN			
98		P67	CS7#/DQM1	MTIOC7C/GTIOC1B-C	CRX2		IRQ15	
99		P66	CS6#/DQM0	MTIOC7D/GTIOC2B-C	CTX2			
100		P65	CS5#/CKE					
101		PE7	D15[A15/D15]	MTIOC6A/GTIOC3A-E/TOC1		MMC_RES#-B/SDHI_WP-B	IRQ7	AN105
102		PE6	D14[A14/D14]	MTIOC6C/GTIOC3B-E/TIC1		MMC_CD-B/SDHI_CD-B	IRQ6	AN104
103	VCC							
104		P70	SDCLK					
105	VSS							
106		PE5	D13[A13/D13]	MTIOC4C/MTIOC2B/GTIOC0A-A	ET0_RX_CLK/REF50CK0		IRQ5	AN103
107		PE4	D12[A12/D12]	MTIOC4D/MTIOC1A/GTIOC1A-A/PO28	ET0_ERXD2			AN102
108		PE3	D11[A11/D11]	MTIOC4B/GTIOC2A-A/PO26/POE8#/TOC3	CTS12#/RTS12#/SS12#/ET0_ERXD3	MMC_D7-B		AN101
109		PE2	D10[A10/D10]	MTIOC4A/GTIOC0B-A/PO23/TIC3	RXD12/SMISO12/SSCL12/RXDX12	MMC_D6-B	IRQ7-DS	AN100
110		PE1	D9[A9/D9]	MTIOC4C/MTIOC3B/GTIOC1B-A/PO18	TXD12/SMOSI12/SSDA12/TXDX12/SIOX12	MMC_D5-B		ANEX1
111		PE0	D8[A8/D8]	MTIOC3D/GTIOC2B-A	SCK12	MMC_D4-B		ANEX0
112		P64	CS4#/WE#					
113		P63	CS3#/CAS#					
114		P62	CS2#/RAS#					
115		P61	CS1#/SDCS#					
116	VSS							

Table 4.1 List of I/O Registers (Address Order) (33 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
0008 C095h	PORTA	Open-Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C096h	PORTB	Open-Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C097h	PORTB	Open-Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C098h	PORTC	Open-Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C099h	PORTC	Open-Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C09Ah	PORTD	Open-Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C09Bh	PORTD	Open-Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C09Ch	PORTE	Open-Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C09Dh	PORTE	Open-Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C09Eh	PORTF	Open-Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C09Fh	PORTF	Open-Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0A0h	PORTG	Open-Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0A1h	PORTG	Open-Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0A4h	PORTJ	Open-Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0A5h	PORTJ	Open-Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0C0h	PORT0	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0C1h	PORT1	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0C2h	PORT2	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0C3h	PORT3	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0C4h	PORT4	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0C5h	PORT5	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0C6h	PORT6	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0C7h	PORT7	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0C8h	PORT8	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0C9h	PORT9	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0CAh	PORTA	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0CBh	PORTB	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0CCh	PORTC	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0CDh	PORTD	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0CEh	PORTE	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C0CFh	PORTF	Pull-Up Resistor Control Register	PCR	8	8	2, 3 PCLKB	2 ICLK	I/O Ports

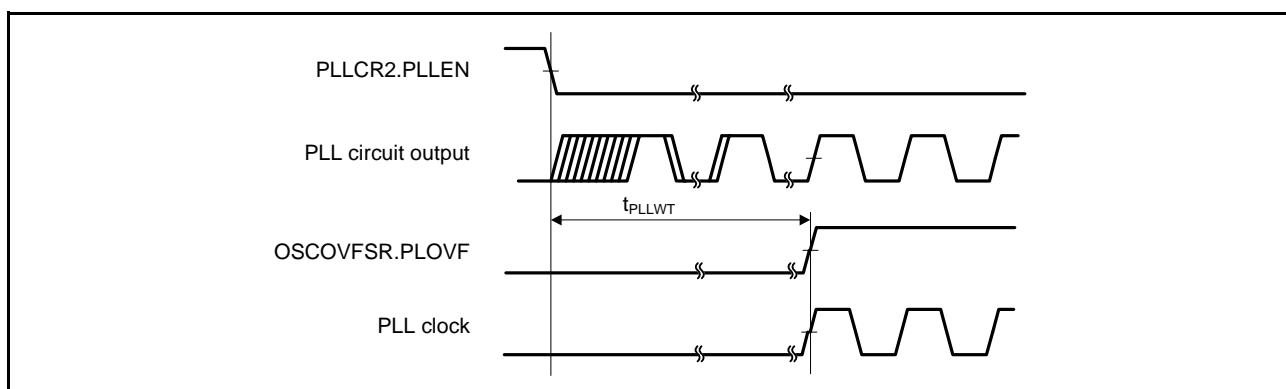
Table 4.1 List of I/O Registers (Address Order) (59 / 67)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles		Related Function
						ICLK ≥ PCLK	ICLK < PCLK	
000C 4C50h	EPTPC_1	Announce Message Flag Field Setting Register	ANFR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C54h	EPTPC_1	Sync Message Flag Field Setting Register	SYNFR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C58h	EPTPC_1	Delay_Req Message Flag Field Setting Register	DYRQFR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C5Ch	EPTPC_1	Delay_Resp Message Flag Field Setting Register	DYRPFR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C60h	EPTPC_1	SYNFP Local Clock ID Registers	SYCIDRU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C64h	EPTPC_1	SYNFP Local Clock ID Registers	SYCIDRL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C68h	EPTPC_1	SYNFP Local Port Number Register	SYPNUMR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C80h	EPTPC_1	SYNFP Register Value Load Directive Register	SYRVLDR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C90h	EPTPC_1	SYNFP Reception Filter Register 1	SYRFL1R	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C94h	EPTPC_1	SYNFP Reception Filter Register 2	SYRFL2R	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4C98h	EPTPC_1	SYNFP Transmission Enable Register	SYTRENR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CA0h	EPTPC_1	Master Clock ID Register	MTCIDU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CA4h	EPTPC_1	Master Clock ID Register	MTCIDL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CA8h	EPTPC_1	Master Clock Port Number Register	MTPID	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CC0h	EPTPC_1	SYNFP Transmission Interval Setting Register	SYTLIR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CC4h	EPTPC_1	SYNFP Received logMessageInterval Value Indication Register	SYRLIR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CC8h	EPTPC_1	offsetFromMaster Value Register	OFMRU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CCCh	EPTPC_1	offsetFromMaster Value Register	OFMRL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CD0h	EPTPC_1	meanPathDelay Value Register	MPDRU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CD4h	EPTPC_1	meanPathDelay Value Register	MPDRL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CE0h	EPTPC_1	grandmasterPriority Field Setting Register	GMPR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CE4h	EPTPC_1	grandmasterClockQuality Field Setting Register	GMCQR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CE8h	EPTPC_1	grandmasterIdentity Field Setting Registers	GMIDRU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CECh	EPTPC_1	grandmasterIdentity Field Setting Registers	GMIDRL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CF0h	EPTPC_1	currentUtcOffset/timeSource Field Setting Register	CUOTSR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4CF4h	EPTPC_1	stepsRemoved Field Setting Register	SRR	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4D00h	EPTPC_1	PTP-primary Message Destination MAC Address Setting Registers	PPMACRU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4D04h	EPTPC_1	PTP-primary Message Destination MAC Address Setting Registers	PPMACRL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4D08h	EPTPC_1	PTP-pdelay Message MAC Address Setting Registers	PDMACRU	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4D0Ch	EPTPC_1	PTP-pdelay Message MAC Address Setting Registers	PDMACRL	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC
000C 4D10h	EPTPC_1	PTP Message EtherType Setting Register	PETYPER	32	32	9 to 211 PCLKA	2 to 106 ICLK	EPTPC

Table 5.16 PLL Clock Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
T_a = T_{opr}

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
PLL clock oscillation frequency	f _{PLL}	120	—	240	MHz	
PLL clock oscillation stabilization wait time	t _{PLLWT}	—	259	320	μs	Figure 5.10

**Figure 5.10 PLL Clock Oscillation Start Timing****Table 5.17 Sub-Clock Timing**

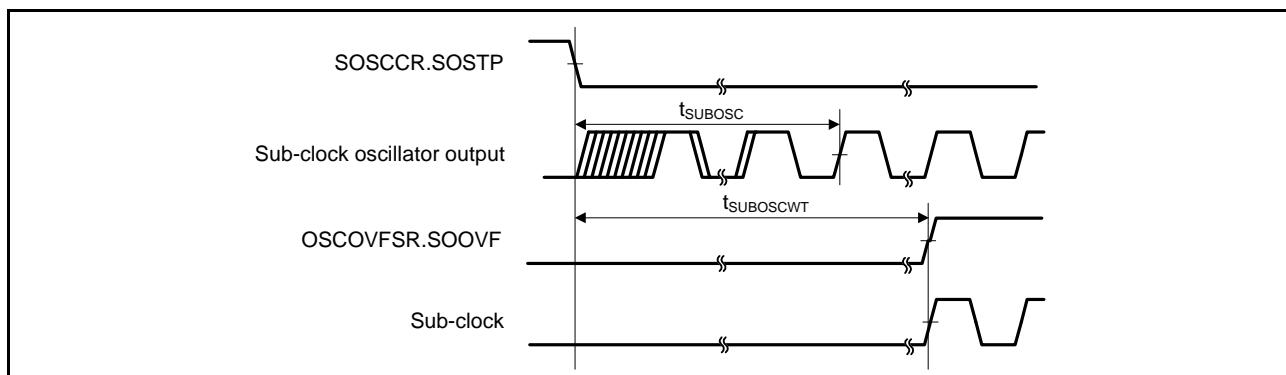
Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
V_{BATT} = 2.0 to 3.6 V, T_a = T_{opr}

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Sub-clock oscillation frequency	f _{SUB}	—	32.768	—	kHz	
Sub-clock oscillation stabilization time	t _{SUBOSC}	—	—	*1	s	Figure 5.11
Sub-clock oscillation stabilization wait time	t _{SUBOSCWT}	—	—	*2	s	

Note 1. When using a sub-clock, ask the manufacturer of the oscillator to evaluate its oscillation. Refer to the results of evaluation provided by the manufacturer for the oscillation stabilization time.

Note 2. The number of cycles selected by the value of the SOSCWT.C.SSTS[7:0] bits determines the sub-clock oscillation stabilization wait time in accord with the formula below.

$$t_{SUBOSCWT} = [(SSTS[7:0] \text{ bits} \times 16384) + 10] / f_{LOCO}$$

**Figure 5.11 Sub-Clock Oscillation Start Timing**

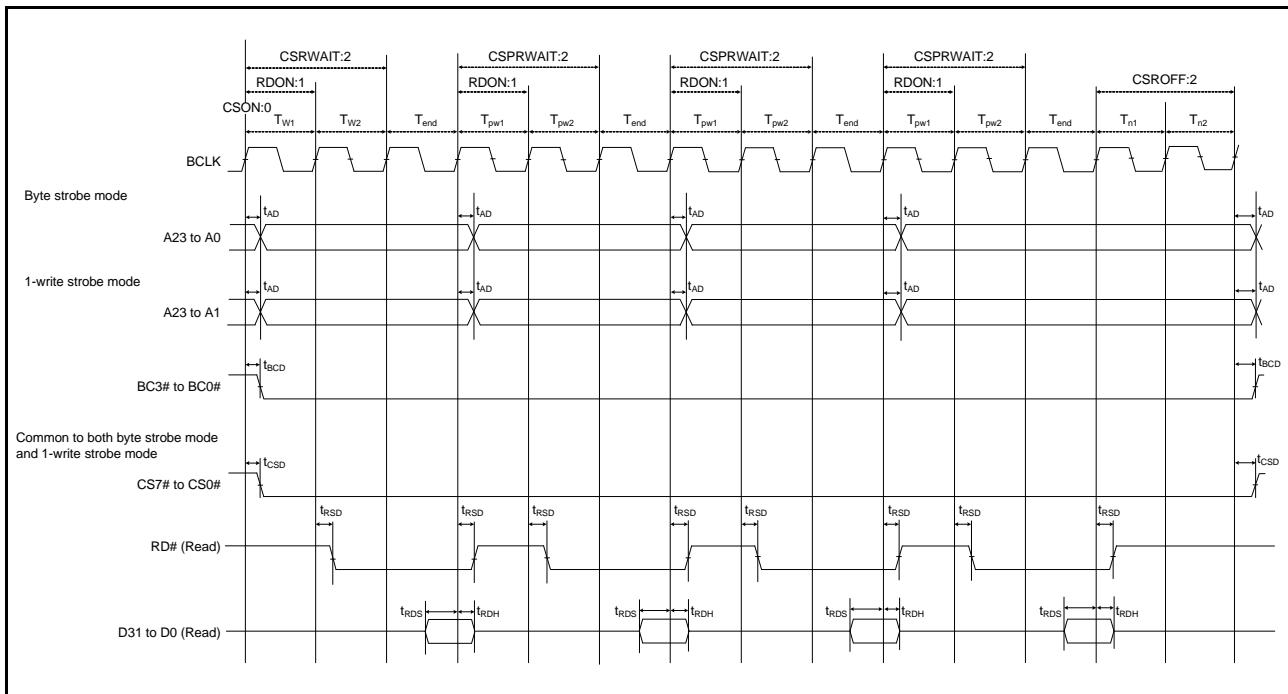


Figure 5.20 External Bus Timing/Page Read Cycle (Bus Clock Synchronized)

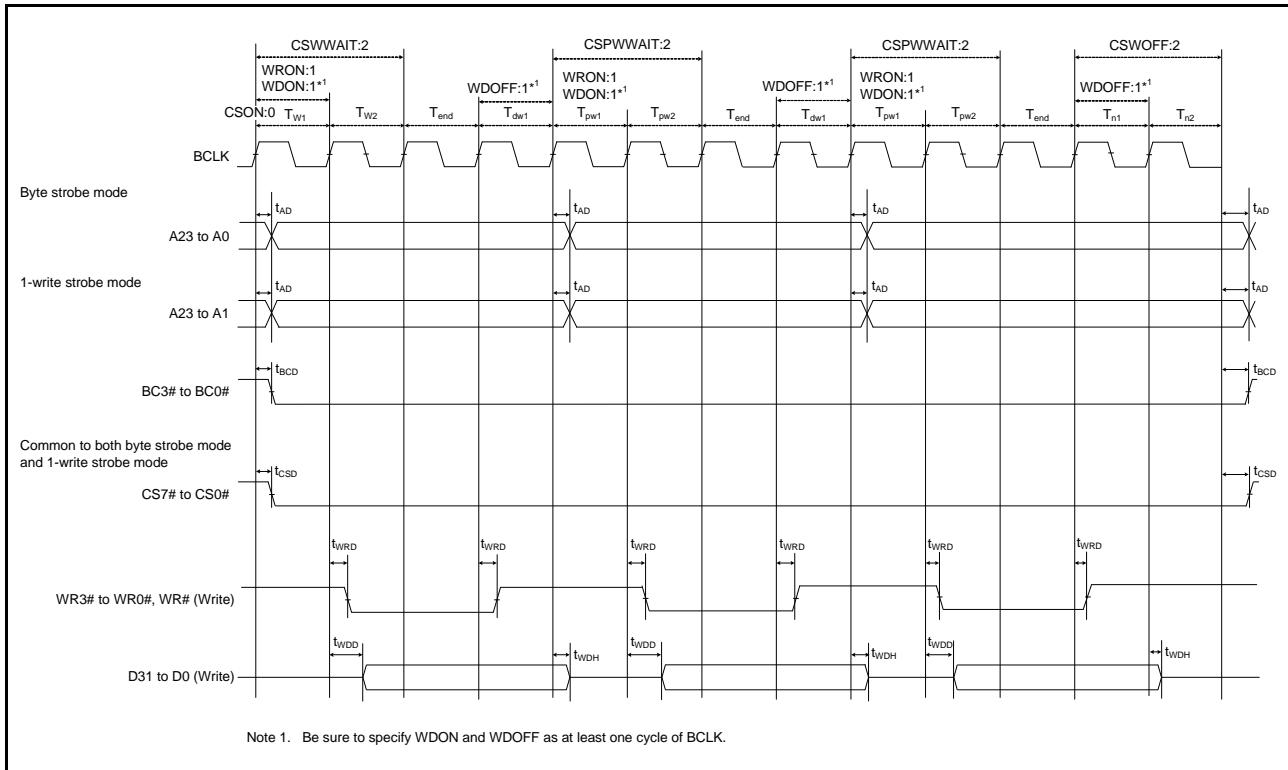


Figure 5.21 External Bus Timing/Page Write Cycle (Bus Clock Synchronized)

Table 5.24 TPU Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
 VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
 VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
 PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, T_a = T_{opr}
 Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
 High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit*1	Test Conditions	
TPU	Input capture input pulse width	Single-edge setting	t _{TICW}	1.5	—	t _{PBcyc}	Figure 5.34
				2.5	—		
	Timer clock pulse width	Single-edge setting	t _{TCKWH} , t _{TCKWL}	1.5	—	t _{PBcyc}	Figure 5.35
		Both-edge setting		2.5	—		
		Phase counting mode		2.5	—		

Note 1. t_{PBcyc}: PCLKB cycle

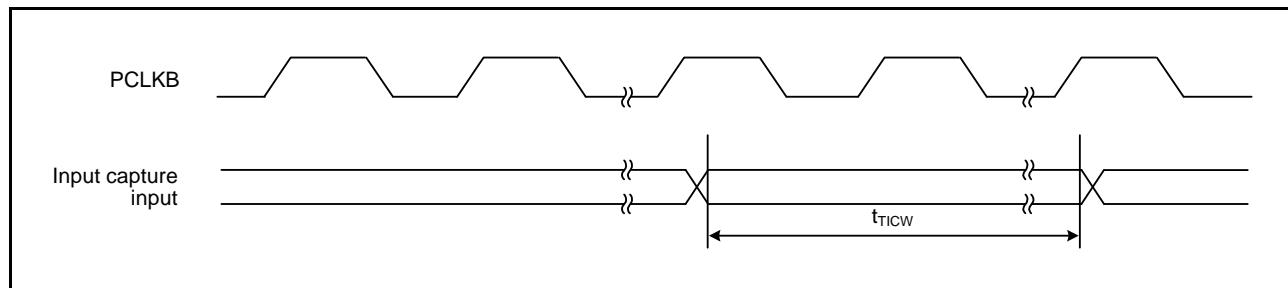
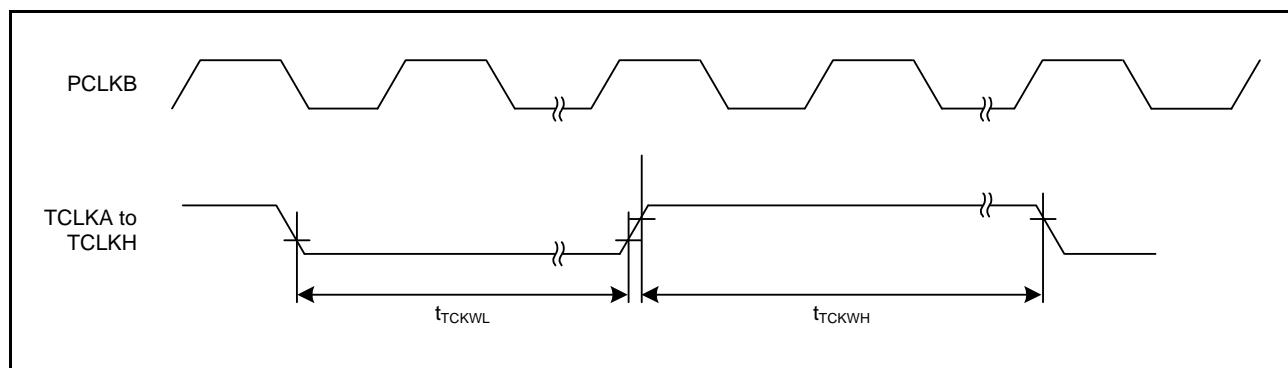
**Figure 5.34 TPU Input Capture Input Timing****Figure 5.35 TPU Clock Input Timing**

Table 5.29 GPT Timing

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
 VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
 VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USB = AVSS_USBA = 0 V,
 PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, T_a = T_{opr}
 Output load conditions: V_{OH} = VCC × 0.5, V_{OL} = VCC × 0.5, C = 30 pF
 High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit ^{*1}	Test Conditions	
GPT	Input capture input pulse width	Single-edge setting	t _{GTCIW}	3	—	t _{PAcyc}	Figure 5.41
				5	—		
	External trigger input pulse width	Single-edge setting	t _{OTETW}	1.5	—	t _{PAcyc}	Figure 5.42
				2.5	—		

Note 1. t_{PAcyc}: PCLKA cycle

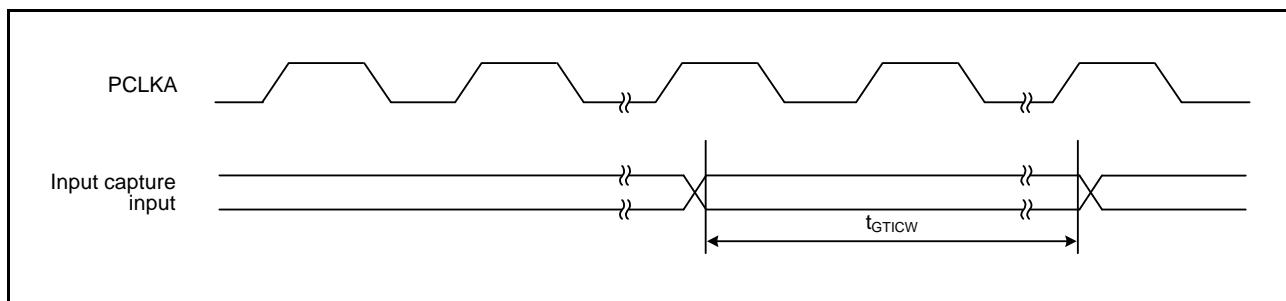
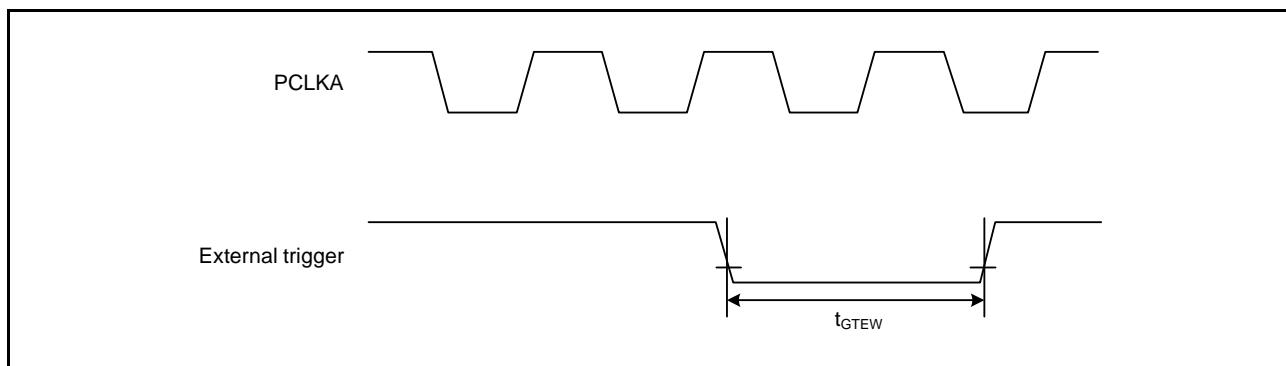
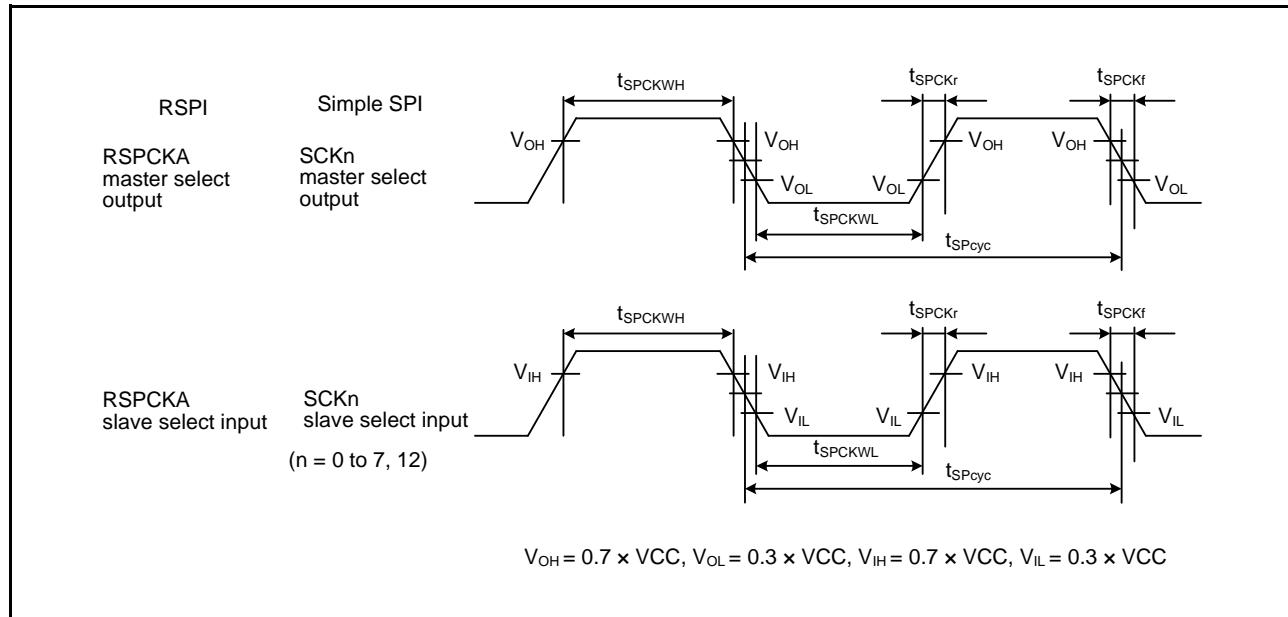
**Figure 5.41 GPT Input Capture Input Timing****Figure 5.42 GPT External Trigger Input Timing**

Table 5.34 Simple SPI Timing

Conditions: $VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7$ to 3.6 V, $2.7 \leq VREFH0 \leq AVCC0$,
 $VCC_USBA = AVCC_USBA = 3.0$ to 3.6 V,
 $VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0$ V,
 $PCLKA = 8$ to 120 MHz, $PCLKB = 8$ to 60 MHz, $T_a = T_{opr}$
Output load conditions: $V_{OH} = VCC \times 0.5$, $V_{OL} = VCC \times 0.5$, $C = 30$ pF
High-drive output is selected by the driving ability control register.

Item		Symbol	Min.	Max.	Unit*1	Test Conditions
Simple SPI	SCK clock cycle output (master)	t_{SPCyc}	4	65536	t_{PBcyc}	Figure 5.46 Figure 5.47 to Figure 5.52
	SCK clock cycle input (slave)		8	65536		
	SCK clock high pulse width	t_{SPCKWH}	0.4	0.6	t_{SPCyc}	
	SCK clock low pulse width	t_{SPCKWL}	0.4	0.6	t_{SPCyc}	
	SCK clock rise/fall time	t_{SPCKr}, t_{SPCKf}	—	20	ns	
	Data input setup time	t_{SU}	33.3	—	ns	
	Data input hold time	t_H	33.3	—	ns	
	SS input setup time	t_{LEAD}	1	—	t_{SPCyc}	
	SS input hold time	t_{LAG}	1	—	t_{SPCyc}	
	Data output delay time	t_{OD}	—	33.3	ns	
	Data output hold time	t_{OH}	-10	—	ns	
	Data rise/fall time	t_{Dr}, t_{Df}	—	16.6	ns	
	SS input rise/fall time	t_{SSLr}, t_{SSLf}	—	16.6	ns	
	Slave access time	t_{SA}	—	5	t_{PBcyc}	Figure 5.51, Figure 5.52
	Slave output release time	t_{REL}	—	5	t_{PBcyc}	

Note 1. t_{PBcyc} : PCLKB cycle

**Figure 5.46 RSPI Clock Timing and Simple SPI Clock Timing**

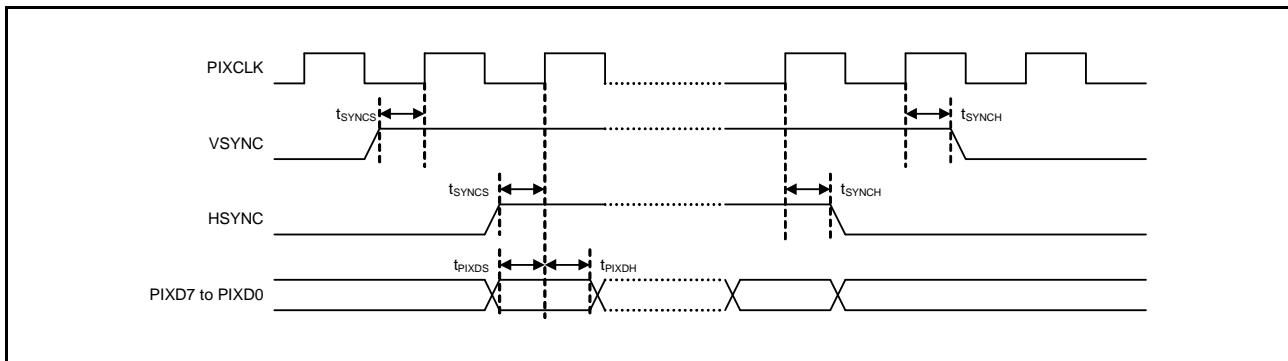


Figure 5.74 PDC AC Timing

5.4 USB Characteristics

Table 5.42 On-Chip USB Low Speed (Host Only) Characteristics (DP and DM Pin Characteristics)

Conditions: $V_{CC} = AVCC_0 = AVCC_1 = VCC_{USB} = V_{BATT} = 3.0$ to 3.6 V, $3.0 \leq VREFH_0 \leq AVCC_0$,
 $VCC_{USBA} = AVCC_{USBA} = 3.0$ to 3.6 V,
 $VSS = AVSS_0 = AVSS_1 = VREFL_0 = VSS_{USB} = VSS_{1_USBA} = VSS_{2_USBA} = PVSS_{USBA} = AVSS_{USBA} = 0$ V,
 $USBA_RREF = 2.2\text{ k}\Omega \pm 1\%$, $USBMCLK = 20/24$ MHz, $UCLK = 48$ MHz,
 $PCLKA = 8$ to 120 MHz, $PCLKB = 8$ to 60 MHz, $T_a = T_{opr}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input characteristics	Input high level voltage	V_{IH}	2.0	—	—	V	
	Input low level voltage	V_{IL}	—	—	0.8	V	
	Differential input sensitivity	V_{DI}	0.2	—	—	V	$ DP - DM $
	Differential common mode range	V_{CM}	0.8	—	2.5	V	
Output characteristics	Output high level voltage	V_{OH}	2.8	—	3.6	V	$I_{OH} = -200\text{ }\mu\text{A}$
	Output low level voltage	V_{OL}	0.0	—	0.3	V	$I_{OL} = 2\text{ mA}$
	Cross-over voltage	V_{CRS}	1.3	—	2.0	V	Figure 5.75
	Rise time	t_{LR}	75	—	300	ns	
	Fall time	t_{LF}	75	—	300	ns	
	Rise/fall time ratio	t_{LR} / t_{LF}	80	—	125	%	t_{LR} / t_{LF}
Pull-down characteristics	DP/DM pull-down resistance (when the host controller function is selected)	R_{pd}	14.25	—	24.80	k Ω	

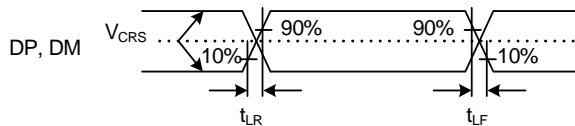


Figure 5.75 DP and DM Output Timing (Low Speed)

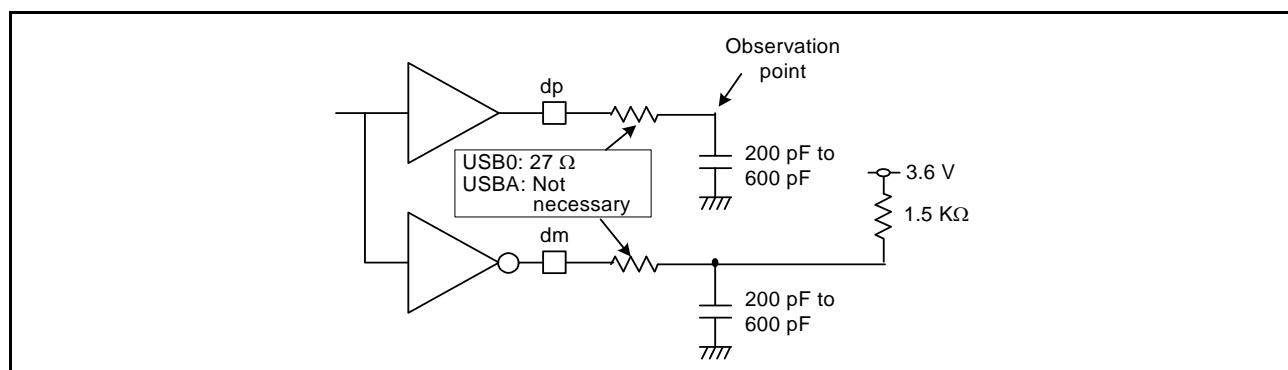
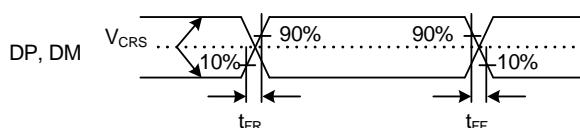
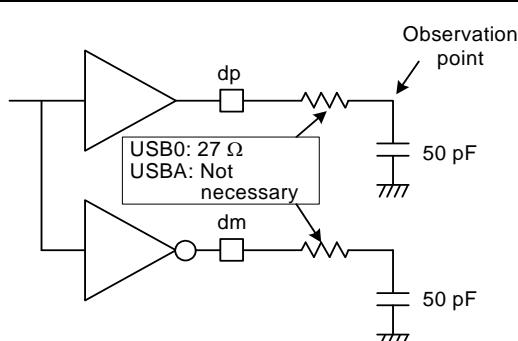


Figure 5.76 Test Circuit (Low Speed)

Table 5.43 On-Chip USB Full-Speed Characteristics (DP and DM Pin Characteristics)

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 3.0 to 3.6 V, 3.0 ≤ VREFH0 ≤ AVCC0,
 VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
 VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
 USBA_RREF = 2.2 kΩ ±1%, USBMCLK = 20/24 MHz, UCLK = 48 MHz,
 PCLKA = 8 to 120 MHz, PCLKB = 8 to 60 MHz, T_a = T_{opr}

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input characteristics	Input high level voltage	V _{IH}	2.0	—	—	V	
	Input low level voltage	V _{IL}	—	—	0.8	V	
	Differential input sensitivity	V _{DI}	0.2	—	—	V	DP – DM
	Differential common mode range	V _{CM}	0.8	—	2.5	V	
Output characteristics	Output high level voltage	V _{OH}	2.8	—	3.6	V	I _{OH} = -200 μA
	Output low level voltage	V _{OL}	0.0	—	0.3	V	I _{OL} = 2 mA
	Cross-over voltage	V _{CRS}	1.3	—	2.0	V	Figure 5.77
	Rise time	t _{FR}	4	—	20	ns	
	Fall time	t _{FF}	4	—	20	ns	
	Rise/fall time ratio	t _{FR} / t _{FF}	90	—	111.11	%	t _{FR} / t _{FF}
Pull-up and pull-down characteristics	DP pull-up resistance (when the function controller function is selected)	R _{pu}	0.900	—	1.575	kΩ	USBFS: Rs = 27 Ω included
			1.425	—	3.090	kΩ	USBA: Rs not necessary (PHYSET.REPSEL[1:0] = 01b and PHYSET.HSEB = 0)
	DP/DM pull-down resistance (when the host controller function is selected)	R _{pd}	14.25	—	24.80	kΩ	

**Figure 5.77 DP and DM Output Timing (Full-Speed)****Figure 5.78 Test Circuit (Full-Speed)**

5.5 A/D Conversion Characteristics

Table 5.45 12-Bit A/D (Unit 0) Conversion Characteristics

Conditions: VCC = AVCC0 = AVCC1 = VCC_USB = V_{BATT} = 2.7 to 3.6 V, 2.7 ≤ VREFH0 ≤ AVCC0,
VCC_USBA = AVCC_USBA = 3.0 to 3.6 V,
VSS = AVSS0 = AVSS1 = VREFL0 = VSS_USB = VSS1_USBA = VSS2_USBA = PVSS_USBA = AVSS_USBA = 0 V,
PCLKB = PCLKC = 1 MHz to 60 MHz, T_a = T_{opr}

Item		Min.	Typ.	Max.	Unit	Test Conditions
Resolution		8	—	12	Bit	
Analog input capacitance		—	—	30	pF	
Channel-dedicated sample-and-hold circuits in use (AN000 to AN002)	Conversion time* ¹ (Operation at PCLK = 60 MHz) Permissible signal source impedance (max.) = 1.0 kΩ	1.06 (0.40 + 0.25) ^{*2}	—	—	μs	<ul style="list-style-type: none"> Sampling of channel-dedicated sample-and-hold circuits in 24 states Sampling in 15 states
	Offset error	—	±1.5	±3.5	LSB	AN000 to AN002 = 0.25 V
	Full-scale error	—	±1.5	±3.5	LSB	AN000 to AN002 = VREFH0 - 0.25 V
	Quantization error	—	±0.5	—	LSB	
	Absolute accuracy	—	±2.5	±5.5	LSB	
	DNL differential nonlinearity error	—	±1.0	±2.0	LSB	
	INL integral nonlinearity error	—	±1.5	±3.0	LSB	
	Holding characteristics of sample-and-hold circuits	—	—	20	μs	
Channel-dedicated sample-and-hold circuits not in use (AN000 to AN007)	Conversion time* ¹ (Operation at PCLK = 60 MHz) Permissible signal source impedance (max.) = 1.0 kΩ	0.48 (0.267) ^{*2}	—	—	μs	Sampling in 16 states
	Offset error	—	±1.0	±2.5	LSB	
	Full-scale error	—	±1.0	±2.5	LSB	
	Quantization error	—	±0.5	—	LSB	
	Absolute accuracy	—	±2.0	±4.5	LSB	
	DNL differential nonlinearity error	—	±0.5	±1.5	LSB	
	INL integral nonlinearity error	—	±1.0	±2.5	LSB	

Note: The above specification values apply when there is no access to the external bus during A/D conversion. If access proceeds during A/D conversion, values may not fall within the above ranges.

Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The value in parentheses indicates the sampling time.

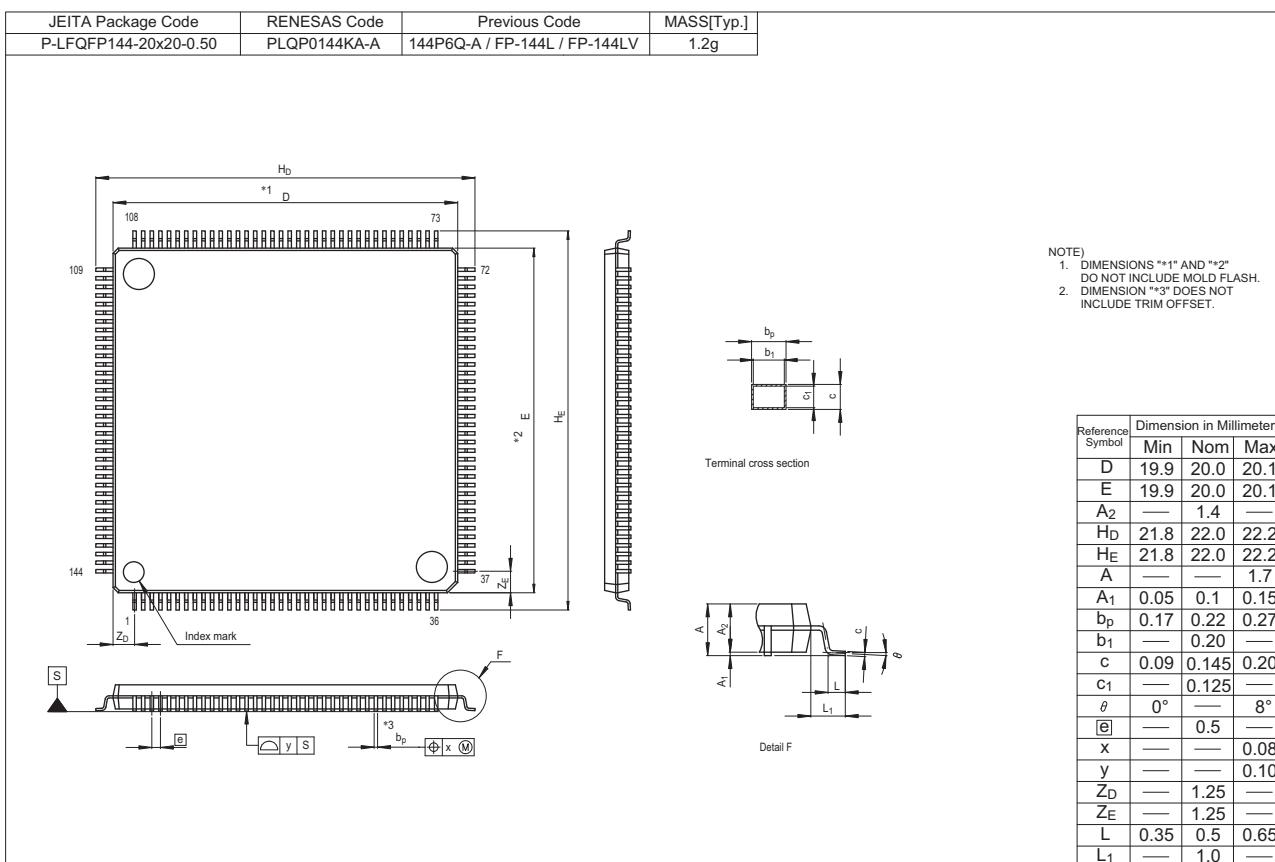


Figure E 144-Pin LFQFP (PLQP0144KA-A)